

MOSFET

OptiMOS™ 6 Power-Transistor, 150 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- MSL 1 classified according to J-STD-020

Product validation

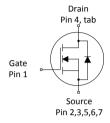
Fully qualified according to JEDEC for Industrial Applications

Table 1 Key Performance Parameters

Parameter	Value	Unit					
$V_{ m DS}$	150	V					
R _{DS(on),max}	2.6	mΩ					
I_{D}	239	А					
Q _{oss}	310	nC					
Q_{G}	105	nC					
Q _{rr} (500A/μs)	220	nC					

D²-PAK 7pin







Type/Ordering Code	Package	Marking	Related Links
IPF026N15NM6	PG-TO263-7	026N15N6	-

Public

OptiMOS™ 6 Power-Transistor, 150 V IPF026N15NM6



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OptiMOS™ 6 Power-Transistor, 150 V IPF026N15NM6



1 Maximum ratings

at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamakar	Cymahal	Values			l lm!h	Nata/Task Condition	
Parameter	Symbol	Min.	Тур.	Мах.	Unit	Note/ Test Condition	
Continuous drain current ¹⁾	I _D	-	-	239 183 172 25	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	956	А	T _C =25 °C	
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	100	А	<i>T</i> _c =25 °C	
Avalanche energy, single pulse	E _{AS}	-	-	1012	mJ	$I_{\rm D}$ =60 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V_{GS}	-20	-	20	V	-	
Power dissipation	P_{tot}	-	-	395 3.8	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾	
Operating and storage temperature	$T_{\rm j}$, $T_{\rm stg}$	-55	-	175	°C	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
raiailletei	Symbol	Min.	Тур.	Мах.	Offic	Note/ Test Condition
Thermal resistance, junction - case	R_{thJC}	-	-	0.38	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area ⁵⁾	R_{thJA}	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	R_{thJA}	-	-	62	°C/W	-

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics

at $T_{\rm j}$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note / Took Condition	
raiailletei	Syllibol	Min.	Тур.	Мах.	Ollic	Note/ Test Condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	150	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.5	4.0	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 276 \mu{\rm A}$	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	$V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C	
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	$R_{\mathrm{DS(on)}}$	-	2.1 2.3 2.5	2.5 2.6 3.0	mΩ	V_{GS} =15 V, I_D =100 A V_{GS} =10 V, I_D =100 A V_{GS} =8 V, I_D =50 A	
Gate resistance	R_{G}	-	1.04	1.56	Ω	-	
Transconductance	g_{fs}	91	180	-	S	$ V_{\rm DS} \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D}=100 \text{ A}$	

Table 5 Dynamic characteristics

Darameter	Symbol	Values			Unit	Note/ Test Condition
Parameter	Symbol Min. Typ. Max		Мах.	Ollic	Note/ Test Condition	
Input capacitance ⁶⁾	C _{iss}	-	7600	9900	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Output capacitance ⁶⁾	C _{oss}	-	2300	3000	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Reverse transfer capacitance ⁶⁾	C _{rss}	-	25	38	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	22	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1. 6 Ω
Rise time	t _r	-	18	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1. 6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	34	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1. 6 Ω
Fall time	t _f	-	20	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.

⁶⁾ Defined by design. Not subject to production test.

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Table 6 Gate charge characteristics 7)

Parameter	Symbol	Values			Unit	Note / Test Condition	
raiailletei	Symbol	Min.	Тур.	Мах.	Oilit	Note/ Test Condition	
Gate to source charge ⁸⁾	$Q_{ m gs}$	-	40	52	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	26	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge ⁸⁾	$Q_{ m gd}$	-	23	35	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q_{sw}	-	37	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total ⁸⁾	Q_{g}	-	105	137	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	$V_{ m plateau}$	-	5.3	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total, sync. FET	$Q_{g(sync)}$	-	89	-	nC	$V_{\rm DS}$ =0.1 V, $V_{\rm GS}$ =0 to 10 V	
Output charge ⁸⁾	$Q_{ m oss}$	-	310	403	nC	V _{DS} =75 V, V _{GS} =0 V	

 $^{^{7)}\ \ \,}$ See "Gate charge waveforms" for parameter definition

Table 7 Reverse diode

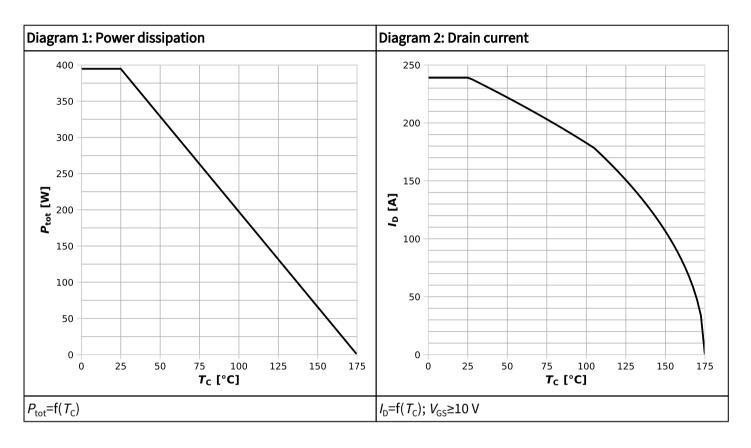
Parameter	Symbol	Values			Unit	Note/ Test Condition	
raiailletei	Symbol	Min.	Тур.	Max.	Oilit		
Diode continuous forward current	Is	-	-	239	А	<i>T</i> _c =25 °C	
Diode pulse current	I _{S,pulse}	-	-	956	А	<i>T</i> _c =25 °C	
Diode forward voltage	$V_{\rm SD}$	-	0.86	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =100 A, $T_{\rm j}$ =25 °C	
Reverse recovery time ⁹⁾	t _{rr}	-	42	84	ns	$V_{\rm R}$ =75 V, $I_{\rm F}$ =50 A, d $i_{\rm F}$ /d t =500 A/ μ s	
Reverse recovery charge ⁹⁾	$Q_{\rm rr}$	-	220	440	nC	$V_{\rm R}$ =75 V, $I_{\rm F}$ =50 A, d $i_{\rm F}$ /d t =500 A/ μ s	
Reverse recovery time ⁹⁾	t _{rr}	-	39	78	ns	$V_{\rm R}$ =75 V, $I_{\rm F}$ =50 A, d $I_{\rm F}$ /d t =1000 A/ μ s	
Reverse recovery charge ⁹⁾	$Q_{\rm rr}$	-	410	820	nC	$V_{\rm R}$ =75 V, $I_{\rm F}$ =50 A, d $i_{\rm F}$ /d t =1000 A/ μ s	

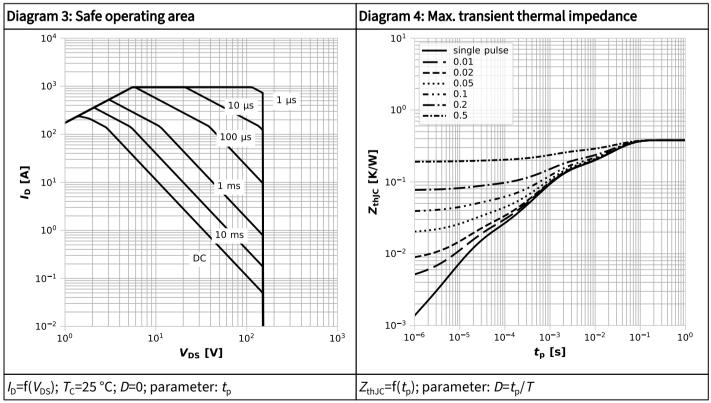
⁹⁾ Defined by design. Not subject to production test.

⁸⁾ Defined by design. Not subject to production test.

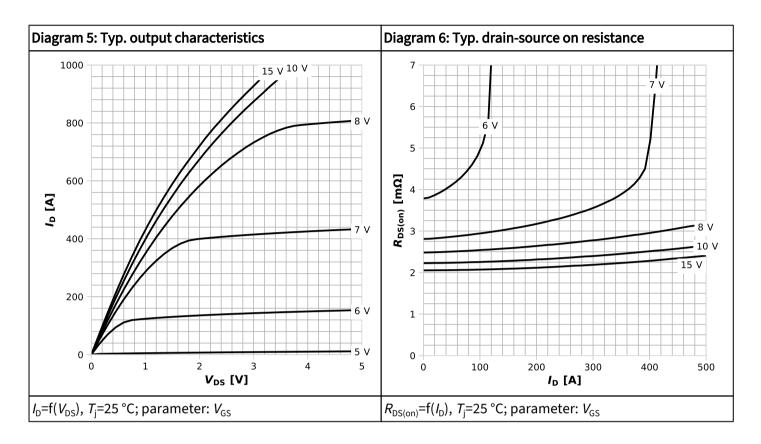


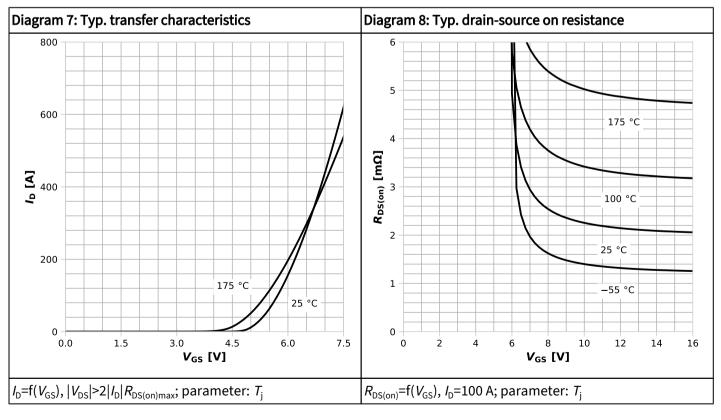
4 Electrical characteristics diagrams



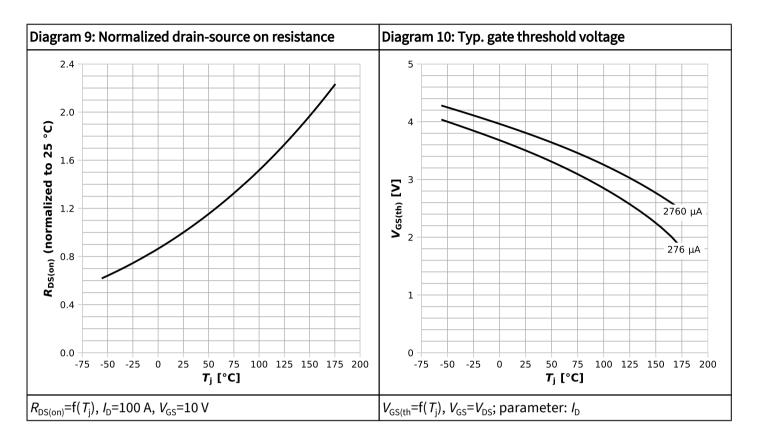


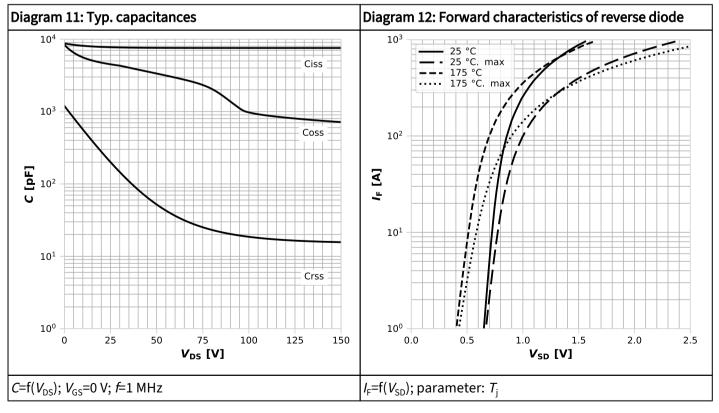




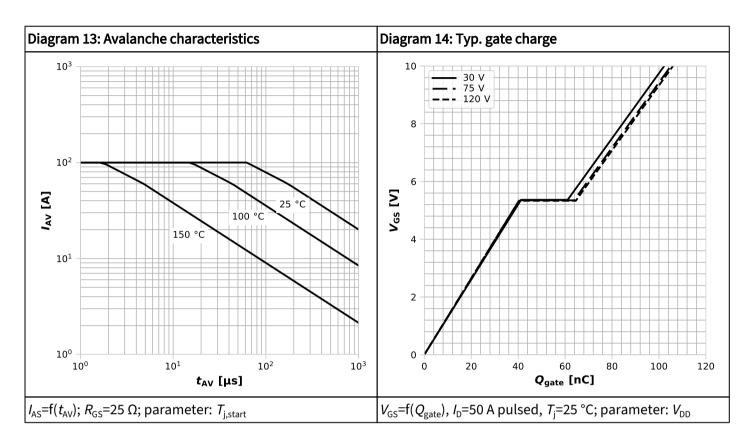


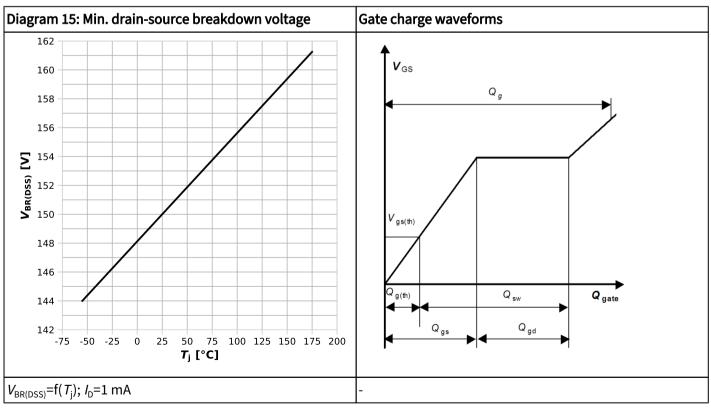














5 Package Outlines

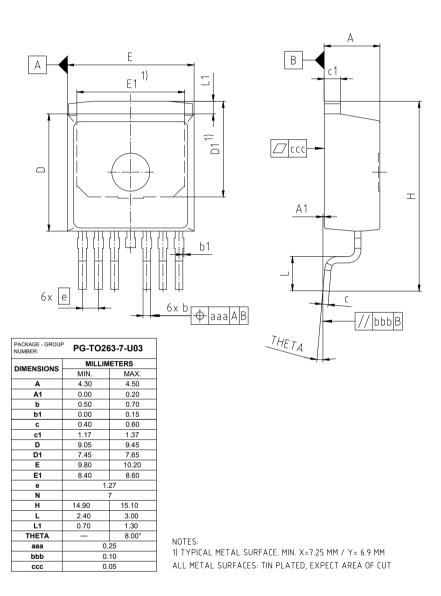


Figure 1 Outline PG-TO263-7, dimensions in mm



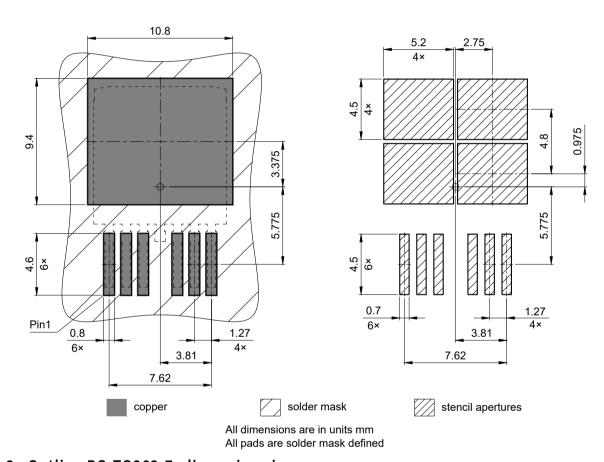


Figure 2 Outline PG-TO263-7, dimensions in mm

OptiMOS™ 6 Power-Transistor, 150 V IPF026N15NM6



Revision History

IPF026N15NM6

Revision 2024-04-22, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
1.0	2024-03-15	Release of preliminary version
2.0	2024-04-22	Release of final

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